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				1	licensors do not warrant that th	e design is production wo	thy. You should completely va	alidate and test your des	ign implementation to confirm the system	n functionality for your application	Engineer: Ahiakwo, Onyx
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	Designed for: Public Relea	ise	Mod. Date:	10/5/2015	_	
	Project Title: 1-2s I2C Li-ion Battery Pack Reference Design					
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